

Dissociative charge transfer reactions of Ar^+ , Ne^+ , and He^+ with CF_4 from thermal to 50 eV

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Guided ion-beam techniques are used to measure the cross sections for reaction of CF_4 with Ar^+ , Ne^+ , and He^+ from thermal to 50 eV. Dissociative charge transfer followed by successive loss of F atoms are the major processes observed. Only CF_x^+ ($x = 1-3$) products are observed in the reactions of Ar^+ and Ne^+ . With He^+ , in addition to the CF_x^+ products, both C^+ and F^+ are seen at high kinetic energies. Reaction rates for these reactions are also given and compared with previous measurements. It is found that the energy dependence of the cross sections can be understood by considering the energies needed to access specific electronic states of the CF_4^+ ion.

INTRODUCTION

Rare gases (Rg) are often an important component of plasmas used to etch and deposit silicon, silicon oxide, and silicon nitride layers. In plasma deposition processes, the starting material often consists of up to 90% rare gas diluents, in addition to the reactive gas. Although these diluents were initially believed to be inert, the amount and identity of the diluent has been found to significantly affect silane¹ and disilane² deposition characteristics. In the case of etching, energetic (1 keV) rare gas ions are often used in tandem with reactive neutral species, such as fluorides, to symbiotically enhance the etch rates and the directionality of the etched features.³⁻⁵ The etch rate is highly dependent on the ion used (Ar^+ , Ne^+ , or He^+), yet the reasons for this dependency are unclear.⁵ In other experimental plasma-etching systems, the substrates are immersed directly in the plasma either at ground or at the floating potential such that low-energy ions (≤ 50 eV) are incident on the substrates.⁶

Carbon tetrafluoride is used extensively in silicon etching plasmas as a source of reactive F atoms. In addition, CF_4/H_2 and CF_4/O_2 plasmas have been found to selectively etch both SiO_2 and Si_3N_4 surfaces in the presence of silicon surfaces.⁷ Although the active etchant species in these plasmas are not known, it is likely that CF_3 and CF_2 radicals play an important role.⁷ In addition, effective discharge conditions for these systems indicate that ion bombardment is required to initiate the selective etching.⁸ Several possibilities exist for the mechanism responsible for ion-enhanced etching. The two primary mechanisms believed to be important are ion bombardment-induced gasification of the stable surface layer of fluorinated silicon formed when silicon is exposed to fluorine⁸ and ion bombardment damage created in the near-surface region where impinging molecules react more rapidly at the damaged sites.⁹ In addition to these mechanisms, ions also may promote chemical reactions involving other species, or may react directly with the substrate. With rare gas ions, dissociative charge transfer reactions could also be of importance since CF_3^+ and possibly

CF_2^+ ions are likely to etch SiO_2 with significant probability.^{10,11}

The study of rare gas ion-molecule reactions related to silicon etching and deposition plasmas containing CF_4 has been the focus of recent work. Cross sections for reaction of CF_4 with He^+ and Ne^+ have been measured at high energies (700–5000 eV).¹² Thermal reaction rates have been determined by using drift tube¹³ and ion cyclotron resonance (ICR)¹⁴ techniques. Also, UV emission from the $\text{CF}_4 + \text{Rg}^+$ interactions have been measured at collision energies of 1–1800 eV ($\text{Rg} = \text{Ar}, \text{Ne}, \text{He}$)¹⁵ and 1–25 keV ($\text{Rg} = \text{He}, \text{Ne}$).¹⁶

Recent work in our laboratory has focused on ion-molecule reactions related to plasma systems involving SiF_4 ,^{17,18} and SiCl_4 .¹⁹ The mechanisms involved in the reactions of Si^+ with SiF_4 as well as the thermochemistry of the resulting SiF_x and SiF_x^+ species have been studied.¹⁷ An analogous study was also performed with SiCl_4 .¹⁹ In addition, the reactions of rare gas ions with SiF_4 have also been explored.¹⁸ The present work is a continuation of these studies.

EXPERIMENTAL SECTION

General

The ion-beam apparatus and experimental techniques used in this work are described in detail elsewhere.²⁰ The rare gas ions are produced as described below. The $^4\text{He}^+$, $^{22}\text{Ne}^+$, and $^{40}\text{Ar}^+$ ions are each mass analyzed and decelerated to the desired translational energy. The ion beam is injected into an rf octopole ion beam guide,²¹ which passes through the reaction cell containing the CF_4 reactant gas. The CF_4 pressure is maintained sufficiently low, 0.01–0.1 mTorr, so that multiple ion-molecule collisions are improbable. The unreacted rare gas and product ions drift out of the gas chamber to the end of the octopole, where they are extracted and analyzed in a quadrupole mass filter. Ions are detected by a secondary electron scintillation ion counter using standard pulse counting techniques. Raw ion intensities are converted to absolute reaction cross sections as described previously.²⁰

Laboratory ion energies (lab) are converted to energies in the center-of-mass frame (c.m.) by using the conversion $E(\text{c.m.}) = E(\text{lab}) \cdot M / (m + M)$, where m is the ion mass and M is the CF_4 molecule mass.²⁰ This conversion factor is

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0.96 for the He⁺ reactions, 0.80 for the Ne⁺ reactions, and 0.69 for the Ar⁺ reactions. Unless stated otherwise, all energies quoted in this work correspond to the c. m. frame. The kinetic energy zero and the full width at half-maximum (FWHM) of the ion kinetic energy distribution are determined by using the octopole beam guide as a retarding potential analyzer.²⁰ The uncertainty in the absolute energy scale is ± 0.05 eV (lab). The distribution of ion energies have an average FWHM of 0.6 eV (lab) for He⁺, 0.4 eV (lab) for Ne⁺, and 0.3 eV (lab) for Ar⁺.

Ion source

The rare gas ions are produced by electron impact of helium, neon, or argon gas, which have ionization potentials (I.P.) of 24.580, 21.559, and 15.755 eV, respectively.²² The first excited electronic states of the ions are 65.4, 48.5, and 29.3 eV, respectively, above the neutral ground states.²² Thus, to prevent formation of ionic excited states, the nominal electron energies used are 50, 35, and 20 eV, respectively. The electron energy distribution has a spread of less than ± 1.0 eV in each case. Only the ²S_{1/2} ground state of He⁺ is formed, but both the ²P_{3/2} and ²P_{1/2} spin-orbit states of Ne⁺ and Ar⁺ are produced, presumably with a 2:1 statistical population. The ²P_{1/2} states of Ne⁺ and Ar⁺ lie 0.097 and 0.178 eV, respectively, above the ²P_{3/2} ground states.²² The ²²Ne⁺ isotope was used due to contamination by an impurity ion of mass 20 in the ²⁰Ne⁺ beam.

Ion collection efficiency

For charge transfer and dissociative charge transfer reactions, products may be formed through a long-range electron transfer such that little or no forward momentum is imparted to the ionic products.²³ In such instances, it is possible that up to 50% of these ions have no forward velocity in the laboratory and will not drift out of the octopole to the detector. Such slow product ions which do traverse the octopole may be inefficiently transmitted through the quadrupole mass filter.²⁰ Exothermic or nearly thermoneutral reaction channels, in particular, can be subject to these effects. Cross-section features and magnitudes for these channels were indeed found to be sensitive to the extraction and focusing conditions following the octopole. Results reported here were reproduced on several occasions and cross-section magnitudes shown are averaged results from all these data sets. Based on reproducibility, the uncertainty in the absolute cross sections is estimated as 40% in the Ne and Ar systems. The uncertainty for the He system is larger, 50–60%, due to difficulties associated with collecting low mass ions such as He⁺. These problems have been discussed previously²⁴ and are minimized here by optimizing the collection and detection efficiency for low-mass products.

Thermochemical analysis

Exothermic reaction cross sections are usually described using the Langevin–Gioumousis–Stevenson (LGS) model²⁵

$$\sigma_{\text{LGS}} = \pi e(2\alpha/E)^{1/2}, \quad (1)$$

where e is the electron charge, α is the polarizability of the

target molecule CF₄, and E is the relative kinetic energy of the reactants. Many exothermic reaction cross sections follow this type of energy dependence, although deviations from this behavior are commonly seen.²⁶ The polarizability of CF₄ is not well established. Calculated values for $\alpha(\text{CF}_4)$ extend from 2.38²⁷ to 3.91²⁸ Å³, and experimental values range from 2.82²⁹–2.92³⁰ Å³. Here, we take the polarizability to be 2.92 Å³.

At high kinetic energies, the collision cross section σ_{col} for charge transfer reactions may best be represented by the hard-sphere limit, given by

$$\sigma_{\text{HS}} = \pi R^2. \quad (2)$$

R is roughly estimated by $r_e(\text{Rg}^+-\text{F}) + r_e(\text{F}_3\text{C}-\text{F})$, where $r_e(\text{F}_3\text{C}-\text{F}) = 1.32$ Å.³¹ For ArF⁺, NeF⁺, and HeF⁺, the r_e values used here are 2.0, 1.56, and 1.33 Å, respectively.³² This results in $\sigma_{\text{HS}}(\text{Ar}^+-\text{CF}_4) = 35$ Å², $\sigma_{\text{HS}}(\text{Ne}^+-\text{CF}_4) = 26$ Å², and $\sigma_{\text{HS}}(\text{He}^+-\text{CF}_4) = 22$ Å². In this work, σ_{col} is taken to be the maximum of σ_{LGS} and σ_{HS} .

Cross sections for endothermic reactions of species having a distribution of electronic states, denoted by i , can be analyzed by using

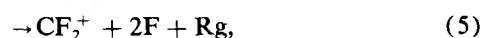
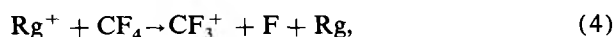
$$\sigma(E) = \sum_i g_i \sigma_{i0} (E - E_0 + E_i)^n / E^m, \quad (3)$$

which involves an explicit sum of the contributions of individual states weighted by their populations g_i . Here, E_0 is the threshold for reaction of the lowest electronic level of the ion, E_i is the electronic excitation of each particular J level, σ_{i0} is an energy-independent scaling factor, and n and m are parameters which depend on the theoretical model being used. For the $J = 3/2$ and $J = 1/2$ spin-orbit states of the reactant ions Ar⁺ and Ne⁺, a 2:1 statistical population and equal reactivity are assumed, so that $g_{3/2} = 2/3$ and $g_{1/2} = 1/3$. Equation (3) has only a single term for He⁺, since the ²S_{1/2} state is the only electronic state of the ion formed.

In this study, Eq. (3) is evaluated for the cases where $m = 1$ for each endothermic reaction channel. The parameters n , σ_{i0} , and E_0 are allowed to vary freely to best fit the data as determined by nonlinear least-squares analysis. This general form and its ability to reproduce the data has been discussed previously.³³ A value of $m = 1$ is chosen because this form of Eq. (3) has been derived as a model for translationally driven reactions³⁴ and has been found to be quite useful in describing the shapes of endothermic reaction cross sections and in deriving accurate thermochemistry from the threshold energies for a wide range of systems.^{33,35} Errors in threshold values are determined by the variation in E_0 for the various models applied to several data sets.

RESULTS

For the reactions of rare gas ions with CF₄, there are three CF_x⁺ product ions seen in all three systems, as given in



Formation of CF₄⁺ and RgF⁺ is not seen for any of the rare

gas ions studied here. In processes (5) and (6), fluorine can conceivably be liberated as either molecular fluorine or separated atoms. Although loss of F₂ is energetically favored over the loss of two F atoms (by 1.6 eV), the loss of F atoms is expected to be kinetically favored since it proceeds through a loose transition state and can more readily conserve angular momentum. Exclusive loss of F atoms was found in the similar Rg⁺ + SiF₄ system.¹⁸

Ar⁺ + CF₄

Results for the reaction of Ar⁺ + CF₄ are shown in Fig. 1. At the lowest energies (below 0.1 eV), the total cross section declines as $(26 \pm 10) E^{-0.50 \pm 0.05}$. This behavior is in good agreement with the LGS model of Eq. (1) $\sigma_{\text{LGS}} = 29 E^{-0.50}$. Between 0.1 and 2.5 eV, the cross section decreases more slowly as $E^{-0.3 \pm 0.04}$, and at a higher kinetic energies, the cross section levels off at about $34 \text{ \AA}^2 \approx \sigma_{\text{HS}}$. The observation that σ_{tot} is essentially equivalent to σ_{col} indicates that reaction occurs with 100% efficiency at all kinetic energies.

At all energies, formation of CF₃⁺ [process (4)] is favored by at least an order of magnitude over other processes. At the lowest energies, the CF₃⁺ cross section increases monotonically as the energy decreases, indicating an exothermic process. Indeed, the thermochemistry in Table I verifies that reaction (4) is exothermic by 1.07 ± 0.05 eV.

Reaction channels (5) and (6) are both highly endothermic processes. For CF₂⁺ production, the apparent threshold is at ~ 6.0 eV. Analysis of this cross section using Eq. (3) leads to a reaction threshold of 6.55 ± 0.14 eV. These values are both well above the thermodynamic threshold for formation of CF₂⁺ + 2F, 4.77 ± 0.13 eV (Table I). The CF⁺ ion has an apparent threshold of ~ 10.5 eV, about

TABLE I. Heats of formation at 298 K (eV).^a

Species	$\Delta_f H^0$	Species	$\Delta_f H^0$
C ⁺	18.754 (0.005)	F	0.823 (0.003)
C	7.428 (0.005)	F ⁺	18.311 (0.003)
CF ⁺	11.76 (0.09) ^b	He ⁺	24.652
CF	2.64 (0.09) ^c	Ne ⁺ (² P _{3/2})	21.638
CF ₂ ⁺	9.28 (0.13) ^c	Ne ⁺ (² P _{1/2})	21.735
CF ₂	-2.12 (0.13) ^c	Ar ⁺ (² P _{3/2})	15.824
CF ₃	-4.874 (0.0434)	Ar ⁺ (² P _{1/2})	16.001
CF ₃ ⁺	4.26 (0.043) ^d		
CF ₄	-9.672 (0.0134)		

^a Ion heats of formation are calculated using the convention that the electron is a monatomic gas. Values compared from the literature which use the "stationary electron" convention should be increased by 0.064 eV at 298 K. Unless otherwise noted, values are taken from M. W. Chase, Jr., C. A. Davies, J. R. Downey, Jr., D. J. Frurip, R. A. McDonald, and A. N. Syverud, *JANAF Thermochemical Tables*, 3rd ed. (AIP, New York, 1985); *J. Phys. Chem. Ref. Data* **14**, Suppl. 1, 1 (1985).

^b J. M. Dyke, A. E. Lewis, and A. Morris, *J. Chem. Phys.* **80**, 1382 (1984).

^c S. G. Lias, J. E. Bartmess, J. F. Liebman, J. L. Holmes, R. D. Levin, and W. G. Mallard, *J. Phys. Chem. Ref. Data* **17**, Suppl. 1, 5 (1988).

^d Recommended value from D. W. Berman, J. L. Beauchamp, and L. R. Thorne, *Int. J. Mass Spectrom. Ion Phys.* **39**, 47 (1981).

2.5 eV greater than the threshold for formation of CF⁺ + 3F.

Ne⁺ + CF₄

Figure 2 shows results for the reaction of Ne⁺ with CF₄. Below about 1 eV, the total cross section is well below σ_{LGS} , reacting with only about 10–15% efficiency. At higher ener-

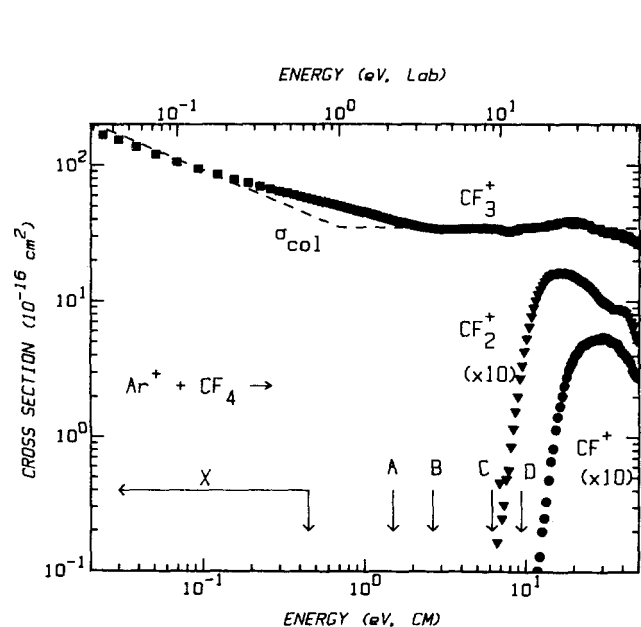


FIG. 1. The variation of product cross sections with translational energy in the laboratory frame of reference (upper scale) and the center-of-mass frame (lower scale) for the reaction of Ar⁺ with CF₄. The dashed line shows the collision cross section, given by the maximum of either the hard sphere or LGS [$\alpha(\text{CF}_4) = 2.92 \text{ \AA}^3$] cross sections [Eqs. (1) and (2)]. The arrows show the $\Delta \text{I.P.}$ values listed in Table III for the CF₄⁺ states labeled.

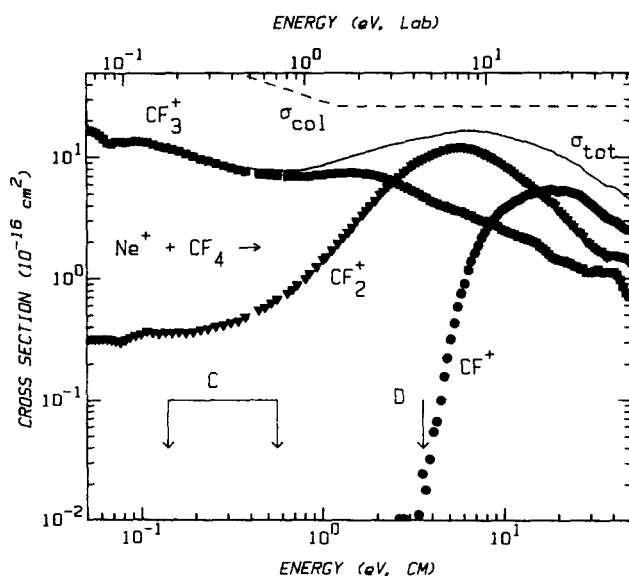


FIG. 2. The variation of product cross sections with translational energy in the laboratory frame of reference (upper scale) and the center-of-mass frame (lower scale) for the reaction of Ne⁺ with CF₄. The solid line shows the total reaction cross section. The dashed line shows the collision cross section, given by the maximum of either the hard sphere or LGS [$\alpha(\text{CF}_4) = 2.92 \text{ \AA}^3$] cross sections [Eqs. (1) and (2)]. The arrows show the $\Delta \text{I.P.}$ values listed in Table III for the CF₄⁺ states labeled. For the C state, both the adiabatic and vertical values are shown.

gies, the maximum total cross section rises to about 65% σ_{col} , but then declines again.

The CF₃⁺ product cross section shows exothermic behavior, increasing as the kinetic energy decreases. Although reaction (4) is exothermic by 6.88 ± 0.05 eV (Table I) this process is not very efficient even at the lowest energies (Fig. 2). At about 0.5 eV, a small second feature in the cross section begins, rises to a maximum of $\sim 8 \text{ \AA}^2$ at about 1.5 eV, and then decreases steadily thereafter. This decline is associated with a concomitant rise in the CF₂⁺ cross section.

Process (5), the production of CF₂⁺ + 2F, is exothermic by 1.04 ± 0.13 eV (Table I). The cross section for this process, however, does not increase monotonically with decreasing energy, as is typical for exothermic reactions. Above ~ 0.5 eV, the cross section for process (5) rises sharply and dominates the reactivity until about 12 eV. The CF₂⁺ cross section declines significantly as process (6), the production of CF⁺, becomes thermodynamically available, and at the highest energies, process (6) dominates the reactivity. Formation of CF⁺ is endothermic, with an apparent threshold of ~ 3.5 eV. Analysis of this cross section using Eq. (3) yields a threshold of 4.03 ± 0.15 eV. Again, these values are higher than that calculated from Table I, 2.26 ± 0.09 eV.

The branching ratio between processes (4) and (5) in the Ne system is 96:4 at the lowest energies. As the kinetic energy increases, the branching ratio changes dramatically, with process (5) dominating over process (4), and by ~ 4.0 eV, the branching ratio between processes (4) and (5) has almost completely reversed to 20:80. Parker and El-Ashhab (PE) have measured the branching ratios for the Rg⁺ + CF₄ systems at very high energies for Rg = Ne.¹² PE use 1000 eV Ne⁺ ions and measure a product distribution of 32% CF₃⁺, 25% CF₂⁺, 17% CF⁺, 14% F⁺, and 12% C⁺. We measure a product distribution between processes (4)–(6) at 50 eV of 53% CF₃⁺, 32% CF₂⁺, and 15% CF⁺.

He⁺ + CF₄

Reaction of He⁺ with CF₄ (Fig. 3) is significantly different than those of Ar⁺ and Ne⁺. In addition to processes (4)–(6), formation of C⁺ and F⁺ are also seen at high kinetic energies. At all energies, the total cross section is well below the LGS prediction. Above 40 eV, the total cross-section magnitude levels off at nearly 60% of the collision limit.

Processes (4)–(6) are all exothermic based on Table I. At the lowest energies, the cross sections for processes (4) and (5) increase with decreasing energy, indicating exothermic processes, but these features decline at about $E^{-1.4 \pm 0.1}$. In addition, both cross sections have second features which begin between 2 and 4 eV. Formation of CF⁺ [reaction (6)] is also exothermic (by 0.76 ± 0.09 eV, Table I), but, unlike processes (4) and (5), has only one feature^{36,37} which is strongly endothermic. The apparent threshold is ~ 3.8 eV.

The final two reaction channels observed in the reaction of He⁺ with CF₄ are formation of C⁺ [process (7)] and formation of F⁺ [process (8)]

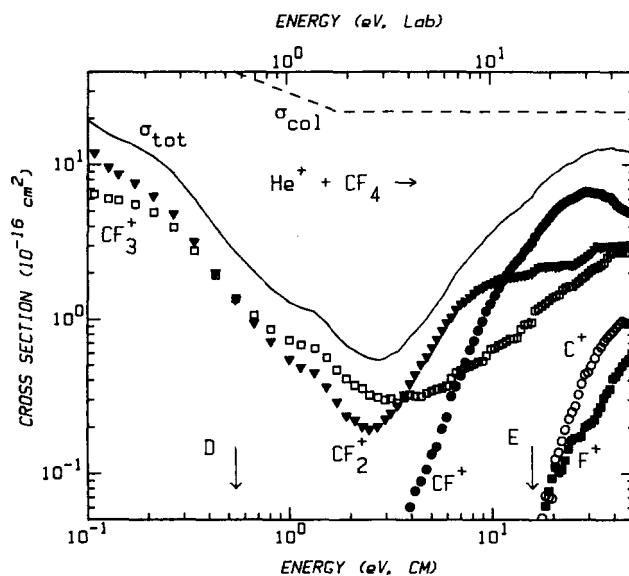
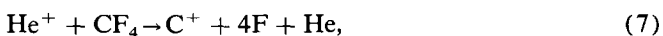


FIG. 3. The variation of product cross sections with translational energy in the laboratory frame of reference (upper scale) and the center-of-mass frame (lower scale) for the reaction of He⁺ with CF₄. The solid line shows the total reaction cross section. The dashed line shows the collision cross section, given by the maximum of either the hard sphere or LGS [$\alpha(\text{CF}_4) = 2.92 \text{ \AA}^3$] cross sections [Eqs. (1) and (2)]. The arrows show the $\Delta I.P.$ values listed in Table III for the CF₄⁺ states labeled.

Reaction (7) is endothermic by 7.1 ± 0.1 eV (Table I) well below the apparent threshold of ~ 15 eV. Reaction (8) is exothermic by 1.55 ± 0.05 eV for $x = 0$, and endothermic by 2.0 ± 0.1 , 7.6 ± 0.1 , and 13.22 ± 0.02 eV for $x = 1, 2$, and 3 , respectively. The apparent threshold of ~ 11 eV indicates that the neutral fragments could include any of the fluoro-carbon species CF, CF₂, or CF₃. The apparent threshold energy is too low, however, for complete atomization to be occurring.

The branching ratio between processes (4) and (5) in the He system is 35:65 at the lowest energies. This compares favorably with the measurement of 30:70 made by Richter and Lindinger (RL) at thermal energies.¹³ From 0.4 to about 4.0 eV, the branching ratio rises from 50:50 to 60:40, where process (5) again dominates over process (4) at about $40:60 \pm 10$. In the He system, PE have also studied the reaction of He⁺ + CF₄ at high kinetic energies. They use 900 eV He⁺ ions and measure a product distribution of 54% CF₃⁺, 24% CF₂⁺, 10% CF⁺, 5% F⁺, and 4% C⁺. At the highest energies studied here, 50 eV, we measure a distribution of 23% CF₃⁺, 26% CF₂⁺, 39% CF⁺, 5% F⁺, and 7% C⁺. We speculate that PE observe less product dissociation than is seen here due to the configuration of their apparatus which discriminates against products formed with smaller impact parameters.

DISCUSSION

Reaction rates

Although kinetic rates for many reactions occurring in a plasma environment have been measured or estimated, the collection of kinetic data for these plasma systems is not complete. Figure 4 shows the total reaction rate constants as

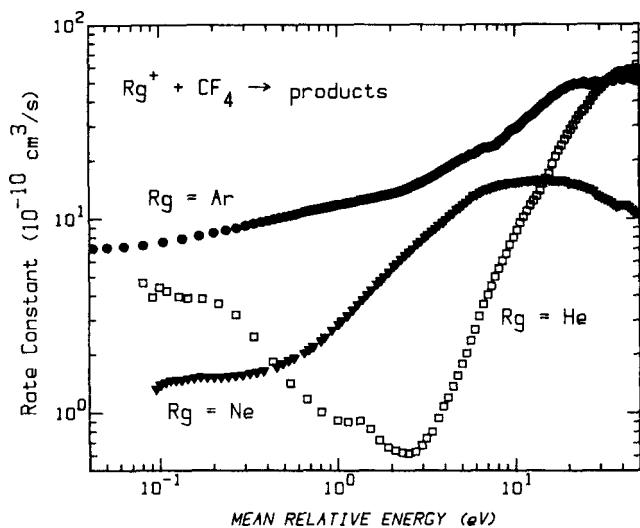


FIG. 4. Phenomenological rate constants for the reaction $Rg^+ + CF_4$ ($Rg = Ar, Ne, \text{ and He}$) as a function of mean relative energy.

a function of energy for all three reaction systems.³⁸ For $Rg = Ar$ and Ne , the reaction rates are relatively constant at low energies, increase steadily as a function of energy, until they reach a maximum. The He system is markedly different. Although the reaction rate is fairly constant between 0.1 and ~ 0.2 eV, it decreases steadily between 0.2 and 3 eV. The reaction rate then rises sharply to a maximum of $\sim 60 \times 10^{-10} \text{ cm}^3 \text{ s}^{-1}$.

Thermal reaction rate coefficients for the exothermic reactions measured here are given in Table II along with the LGS rate coefficients for the three rare gas systems. In the Ar system, the total rate for reaction is simply the rate for process (4), formation of CF_3^+ , which proceeds at unit efficiency at all energies. Richter and Lindinger (RL) have used drift tube techniques to determine total reaction rates for the $Rg^+ + CF_4$ systems with $Rg = Ar$.¹³ These thermal values are listed in Table II. For the Ar system, RL also observed that the rate coefficient for process (4) increases to $17.0 \pm 3.4 \times 10^{-10} \text{ cm}^3 \text{ s}^{-1}$ at ~ 3 eV. For comparison, we measure a rate constant of $18.0 \pm 7.2 \times 10^{-10} \text{ cm}^3 \text{ s}^{-1}$ at 3.0 eV. Thus, the rate constants measured here for the Ar system are in good agreement with those of RL. Using ICR tech-

niques, Chau and Bowers (CB) have also measured the total reaction rates for the $Rg^+ + CF_4$ systems ($Rg = Ar, Ne, \text{ and He}$), (Table II).¹⁴ For the Ar system, our value is in good agreement with that measured by CB.

In the Ne system, both processes (4) and (5) contribute to the total reaction rate at thermal energies, which proceeds at only 14% of the LGS rate. For the Ne system, our total rate constant is again in good agreement with that derived by CB (Table II).

Much like the Ne system, both processes (4) and (5) contribute to the thermal rate constants in the He system. We take the near constant region between 0.1 and 0.2 eV to be representative of the thermal rate constant, and thus measure $4.0 \times 10^{-10} \text{ cm}^3 \text{ s}^{-1}$. While somewhat higher than the values obtained by RL and CB (Table II), our value is within the combined uncertainties of these values. RL also measure a total reaction rate of $\sim 0.65 \times 10^{-10} \text{ cm}^3 \text{ s}^{-1}$ at 0.36 eV. We measure a total rate constant for the He system of $2.2 \pm 1.1 \times 10^{-10} \text{ cm}^3 \text{ s}^{-1}$ at 0.36 eV, again over twice the value of RL. While these values are within our generous error limits, the observed discrepancies could be explained by noting that the rate constant in the He system decreases rapidly as a function of energy below 2.0 eV. If the ion energies of RL and CB are somewhat higher than believed, this could cause their measured rates to be lower than the true thermal rate constants.

General behavior and relative reactivity

The behavior displayed in the three Rg systems can be largely explained by examining the photoelectron spectrum (PES) of CF_4 . Such spectra are available from a variety of sources.³⁹⁻⁴¹ Table III lists ionization energies for CF_4 from the UV PES of Brundle, Robin, and Basch (BRB)³⁹ and x-ray PES of Banna and Shirley.⁴⁰ Also listed are $\Delta I.P.$ values, the difference between the CF_4 ionization energies and the ionization potentials of the three rare gases.

In all three Rg systems, no CF_4^+ product is seen. This is similar to the observation that no parent ions have been observed by means of photon or electron impact mass spectrometry.^{31,42} This is because the stable region of the CF_4^+ ground state is not accessible by a vertical transition from the CF_4 molecule. Rather, the region of the X state of CF_4^+

TABLE II. Thermal reaction rate constants.^a

System	Product	Present work	RL ^b	CB ^c	LGS ^d
$Ar^+ + CF_4$	Total (CF_3^+)	7.0 (2.6)	8.0 (1.6)	6.4 (1.3)	7.6
$Ne^+ + CF_4$	CF_3^+	1.28 (0.26)			
	CF_2^+	0.06 (0.02)			
	Total	1.34 (0.40)		1.6 (0.3)	9.5
$He^+ + CF_4$	CF_3^+	1.4 (0.7)			
	CF_2^+	2.6 (1.3)			
	Total	4.0 (2.0)	1.8 (0.4)	2.7 (0.5)	20.5

^aAll rates in units of $10^{-10} \text{ cm}^3 \text{ s}^{-1}$. Uncertainties are in parentheses.

^bRichter and Lindinger (Ref. 13). Assumed 20% error.

^cChau and Bowers (Ref. 14).

^dLangevin-Gioumoussis-Stevens collision rate $\alpha(CF_4) = 2.92 \text{ \AA}^3$.

TABLE III. Adiabatic and vertical ionization potentials for CF₄.^a

Orbital	Adiabatic	Vertical	$\Delta I.P. (Ar)^b$	$\Delta I.P. (Ne)^b$	$\Delta I.P. (He)^b$
X^2T_1	≥ 15.35	16.20	0.02(0.43)		
A^2T_2	17.10	17.40	1.50(0.15)		
B^2E	18.30	18.50	2.65(0.10)		
C^2T_2	21.70	22.12	6.16(0.21)	0.35(0.21)	
D^2A_1	25.12	25.12	9.37	3.56	0.54
E^2T_2	...	40.3 ^c	24.55	18.74	15.72
F^2A_1	...	43.8 ^c	28.05	22.24	19.22

^a Except where noted, values are taken from Ref. 39.

^b $\Delta I.P. (R_g) = I.P. (\text{orbital}) - I.P. (R_g)$ [$R_g = Ar, Ne, \text{ or } He$] where $I.P. (\text{orbital})$ is the mean of the adiabatic and vertical values and the uncertainties (in parentheses) show the spread of these values.

^c Values are from Ref. 40.

which is accessible via a vertical transition, as well as the lower lying *A* and *B* states of CF₄⁺, all predissociate to CF₃⁺ + F.⁴³ In addition, the *C* and *D* states of CF₄⁺ are observed to radiate to the lower-lying states,^{16,42} which then can dissociate.

Argon

The appearance of the Ar⁺ + CF₄ reaction cross sections is nicely explained by referring to the PES of CF₄. The first PES band, the X^1T_1 , occurs at ~ 15 eV, and peaks at about 16 eV (Table III). Argon ions (I.P. = 15.755 eV) are nearly resonant with this band ($\Delta I.P. \approx 0 \pm 0.4$ eV), such that the reaction efficiency is high at all energies and favors CF₃⁺. At higher kinetic energies, Ar⁺ could produce the *A* and *B* states of CF₄⁺, but these also form CF₃⁺ exclusively (since formation of CF₂⁺ requires more energy). Formation of the CF₂⁺ product [reaction (5)] has an apparent threshold of ~ 6.0 eV (Fig. 1) corresponding directly to the $\Delta I.P.$ for the *C* band of CF₄⁺ (Table III). Also the apparent threshold for reaction (6) occurs at ~ 10.0 eV, near the $\Delta I.P.$ for the *D* band of CF₄⁺. Thus, the dissociative charge transfer reactions of argon ions with CF₄ are governed directly by the ability of the reaction system to access the various electronic states of the CF₄⁺ ions. This leads to thresholds for fragmentation which are well above the thermodynamic values.

Neon

The same ideas can be applied to the Ne system. Here, charge transfer from Ne (I.P. = 21.56 eV) to produce the *X*, *A*, or *B* states of CF₄⁺ are all exothermic processes. However, since none of these states are in resonance, Ne⁺ does not react efficiently at low energies with CF₄. As the kinetic energy reaches the $\Delta I.P.$ value for the C^2T_2 band of CF₄⁺, 0.35 ± 0.2 eV, (Table III), the cross section for process (5) and the total cross section increase noticeably (Fig. 2). Further, the $\Delta I.P.$ value for the *D* state of CF₄⁺ corresponds nicely to the apparent threshold (~ 3.5 eV) for CF⁺ formation, process (6) (Fig. 2). As in the Ar system, the reactivity of Ne⁺ with CF₄ is correlated directly to the ability of the system to access higher electronic states of the CF₄⁺ ion. This agrees with the conclusion of Parker and El-Ashhab¹² that Ne⁺ + CF₄ charge transfer at elevated kinetic energies

(1000 eV lab) populates the *C* state of the CF₄⁺ which then predissociates.

Helium

As in the Ne system, helium ions (I.P. = 24.58 eV) are not resonant with any of the CF₄⁺ states (Table III). This is consistent with the relative inefficiency of the reaction between He⁺ and CF₄ at low energies (Fig. 3). The D^2A_1 band has a $\Delta I.P.$ value of 0.54 eV (Table III). This is somewhat below the second features in the CF₂⁺ and CF₃⁺ cross sections and the threshold for the CF⁺ cross section, which do not begin until 2–3 eV. Further evidence that He⁺ charge transfer leads to the *D* state of CF₄⁺ at high kinetic energies (1000 eV lab) comes from the optical emission spectroscopy of Aarts, Mason and Tuckett.⁴² Parker and El-Ashhab¹² have drawn a similar conclusion for 900 eV (lab) energy helium ions.

For the higher energy channels [reactions (7) and (8)], the apparent thresholds of ~ 15 and ~ 11 eV, respectively, do not correspond to any of the $\Delta I.P.$ values in Table III. However, the cross sections for these two reactions do not become appreciable until 15–17 eV, as can be seen in Fig. 3. This rise in the cross sections corresponds nicely to $\Delta I.P.$ for the *E* state of CF₄⁺. Overall, the correlation between the onset of reaction cross section features and the PES bands of CF₄ is not as quantitative in the He system as it is in the Ar and Ne systems; however, there is a qualitative correspondence.

Relation to plasma systems

To predict the optimum physical parameters of a plasma system, it is first necessary to understand the interactions at the substrate and ascertain the primary chemical species responsible for the desired deposition or etching process. The gas-phase chemistry can then be tailored by modifying the starting materials and bias of the substrate to obtain the maximum concentration of reactive species.

CF₄ is used in plasma systems primarily as a source of the reactive F atoms. In addition, the CF₃⁺ and CF₂⁺ ions are of probable importance in the selective etching of SiO₂ and Si₃N₄ surfaces.⁷ Mayer and Barker (MB) have also shown that the relative reactivities of the various CF_x⁺ ions with SiO₂ are proportional to the number of F atoms in the

ion.⁴⁴ Thus, CF₃⁺ and CF₂⁺ ions contribute significantly more to the etching process than do CF⁺ and C⁺. This would suggest the use of Ar over Ne or He in the starting materials for etching of SiO₂ with CF₄ plasmas since the Ar system produces significantly more CF₃⁺ than either the Ne or He systems.

As an additional comparison among the three systems, the reaction in the Ar system occurs with essentially unit efficiency at all energies, whereas in the Ne system, the maximum efficiency is only about 65% of σ_{HS} at about 8 eV, decreasing at higher energies. Although reaction efficiency does reach about 60% of σ_{HS} in the He system, it does so only at the highest energies (above 40 eV). Thus, the bias energy of the substrate in the plasma system can greatly affect the efficiency of reaction between the rare gas ions and CF₄.

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